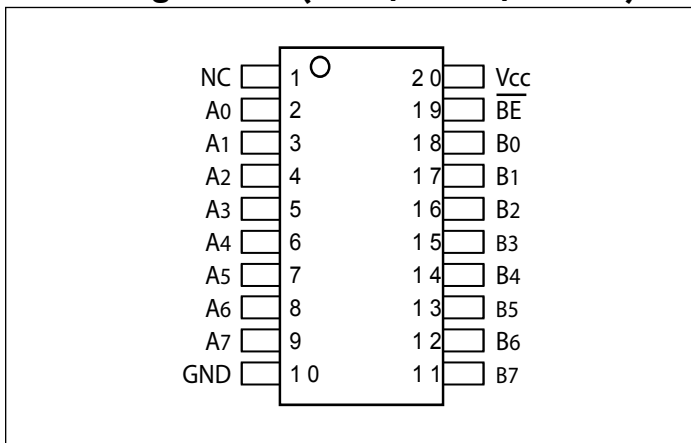


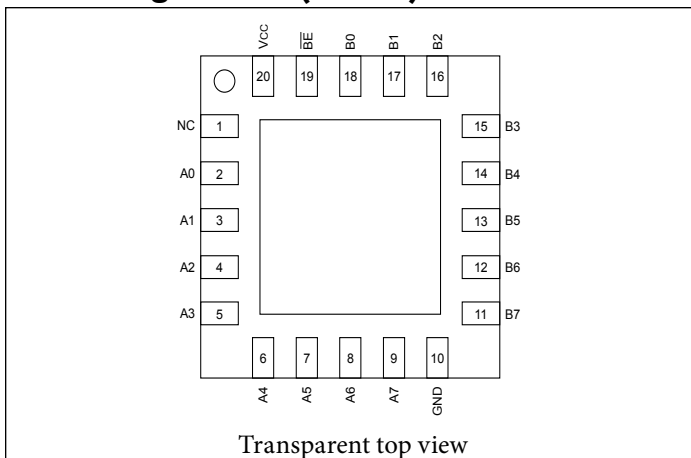
## Features

- Near-Zero propagation delay
- 5-ohm switches connect inputs to outputs
- Fast Switching Speed: 4.5ns (max.)
- Ultra-Low Quiescent Power (0.2µA Typical)
  - Ideally suited for notebook applications
- TTL-compatible control of inputs levels
- ESD protection (2kV Human Body Model and 200V Machine Model)
- Packaging (Pb-free & Green):
  - 20-pin SOIC (S)
  - 20-pin QSOP (Q)
  - 20-pin UQFN (ZUA)
  - 20-pin TSSOP (L)

## Pin Configuration (SOIC, QSOP, TSSOP)



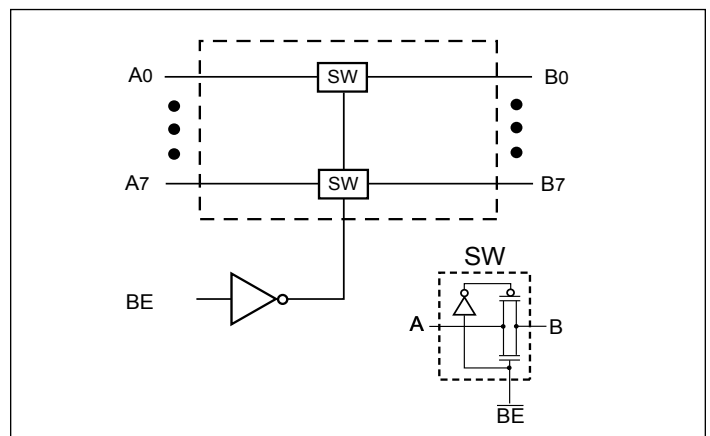
## Pin Configuration (UQFN)



## Description

The PI3B3245 is a 3.3V 8-bit, 2-port bus switch designed with a low On-Resistance (5-ohm) allowing inputs to be connected directly to outputs. The bus switch creates no additional propagational delay or additional ground bounce noise. The switches are turned ON by the Bus Enable ( $\overline{BE}$ ) input signal.

## Block Diagram



## Truth Table

Function	$\overline{BE}$	A0-7
Disconnect	H	Hi-Z
Connect	L	B0-7

Note:

H = High Voltage Level, L = Low Voltage Level, Hi-Z = High Impedance

## Pin Description

Pin Name	Description
$\overline{BE}$	Bus Enable Input (Active LOW)
A0-7	Bus A
B0-7	Bus B
GND	Ground <sup>(1)</sup>
V <sub>CC</sub>	Power

Note 1: UQFN20 package die supply ground is connected to both GND pin and exposed center pad. GND pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the PCB in the thermal pad region.

### Absolute Maximum Ratings

Parameter	Min.	Max.	Units
Storage Temperature	-65	150	°C
Ambient Temperature with Power Applied	-40	85	°C
Supply Voltage to Ground Potential	-0.5	4.6	V
DC Input Voltage	-0.5	4.6	V
DC Output Current	-	120	mA
Power Dissipation	-	0.5	W

Stress beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device.

### DC Electrical Characteristics (Over the Operating Range, $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CC} = 3.3\text{V} \pm 10\%$ )

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units
$V_{IH}$	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
$V_{IL}$	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5		0.8	V
$I_{IH}$	Input HIGH Current	$V_{CC} = \text{Max.}, V_{IN} = V_{CC}$			$\pm 1$	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{CC} = \text{Max.}, V_{IN} = \text{GND}$			$\pm 1$	$\mu\text{A}$
$I_{OZH}$	High Impedance Output Current	$0 \leq A_N, B_N \leq V_{CC}$			$\pm 1$	$\mu\text{A}$
$V_{IK}$	Clamp Diode Voltage	$V_{CC} = \text{Min.}, I_{IN} = -18 \text{ mA}$			-1.2	V
$R_{ON}$	Switch On Resistance <sup>(3)</sup>	$V_{CC} = \text{Min.}, V_{IN} = 0.0\text{V}, I_{ON} = 48\text{mA}$ or 64mA		5	8	$\Omega$
		$V_{CC} = \text{Min.}, V_{IN} = 2.4\text{V}, I_{ON} = 15\text{mA}$		10	17	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $T_A = 25^{\circ}\text{C}$  ambient and maximum loading.
- Measured by the voltage drop between A and B pin at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A,B) pins.

### Capacitance ( $T_A = 25^{\circ}\text{C}$ , $f = 1 \text{ MHz}$ )

Parameters <sup>(1)</sup>	Description	Test Conditions	Typ.	Units
$C_{IN}$	Input Capacitance	$V_{IN} = 0\text{V}$	3.0	pF
$C_{OFF}$	A/B Capacitance, Switch Off	$V_{IN} = 0\text{V}$	8.0	pF
$C_{ON}$	A/B Capacitance, Switch On	$V_{IN} = 0\text{V}$	16.0	pF

Notes:

- This parameter is determined by device characterization but is not production tested.

## Power Supply Characteristics

Parameters	Description	Test Conditions <sup>(1)</sup>		Min.	Typ. <sup>(2)</sup>	Max.	Units
I <sub>CC</sub>	Quiescent Power Supply Current	V <sub>CC</sub> = Max.	V <sub>IN</sub> = GND or V <sub>CC</sub>		0.1	3.0	μA
ΔI <sub>CC</sub>	Supply Current per Input HIGH	V <sub>CC</sub> = Max.	V <sub>IN</sub> = 3.0V <sup>(3)</sup>			750	μA

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V<sub>CC</sub> = 3.3V, +25°C ambient.
3. Per TTL driven input (control input only); A and B pins do not contribute to I<sub>CC</sub>.

## Switching Characteristics over Operating Range

Parameters	Description	Test Conditions	Com.		Units
			Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay <sup>(1,2)</sup> Ax to Bx, Bx to Ax	CL = 50 pF RL = 500Ω		0.25	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Bus Enable Time $\overline{BE}$ to Ax or Bx		1.0	4.0	
t <sub>PHZ</sub> t <sub>PLZ</sub>	Bus Disable Time $\overline{BE}$ to Ax or Bx		1.0	4.5	

Notes:

1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25 ns for 50 pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

## Applications Information

### Logic Inputs

The logic control inputs can be driven up to +3.6V regardless of the supply voltage. For example, given a + 3.3V supply, A<sub>N</sub> may be driven low to 0V and high to 3.6V. Driving B<sub>N</sub> Rail-to-Rail® minimizes power consumption.

### Power-Supply Sequencing and Hot-Plug Information

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V<sub>CC</sub> and GND before applying signals to input/output or control pins.

*Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.*

**PI3B3245**

**Part Marking**

S Package



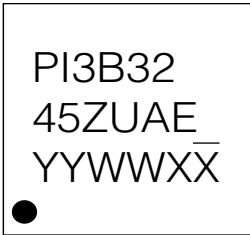
YY: Year  
WW: Workweek  
1st X: Assembly Site Code  
2nd X: Wafer Fab Site Code

Q Package



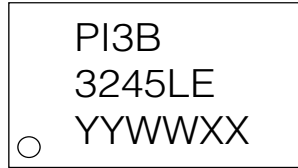
YY: Year  
WW: Workweek  
1st X: Assembly Site Code  
2nd X: Fab Site Code  
Bar above fab code means Cu wire  
Without bar above fab code means Au wire

ZUA Package



YY: Year  
WW: Workweek  
1st X: Assembly Site Code  
2nd X: Fab Site Code

L Package



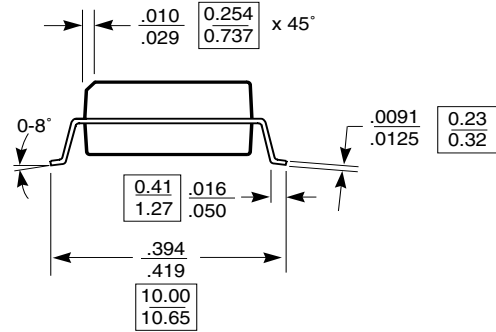
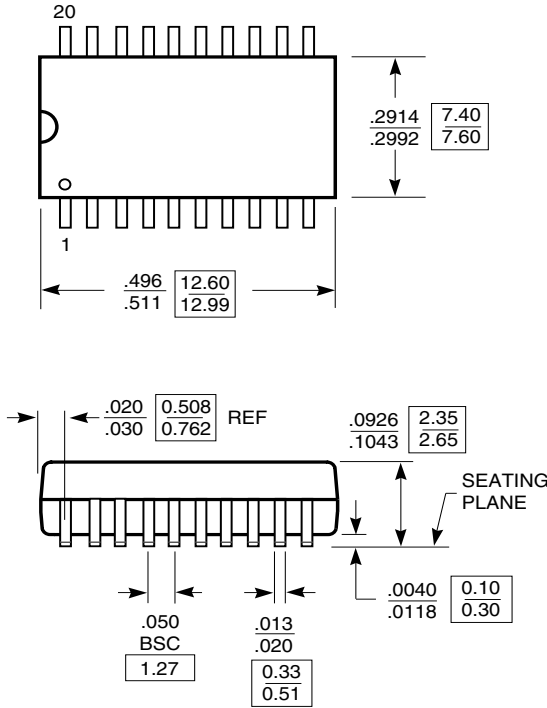
YY: Year  
WW: Workweek  
1st X: Assembly Code  
2nd X: Fab Code

**PI3B3245**

**Packaging Mechanical: 20-SOIC (S)**

DOCUMENT CONTROL NO.  
PD - 1006

REVISION: D  
DATE: 03/09/05



X.XX DENOTES CONTROLLING  
X.XX DIMENSIONS IN MILLIMETERS

Notes:  
 1) Controlling dimensions in millimeters.  
 2) Ref: JEDEC MS-013D/AC



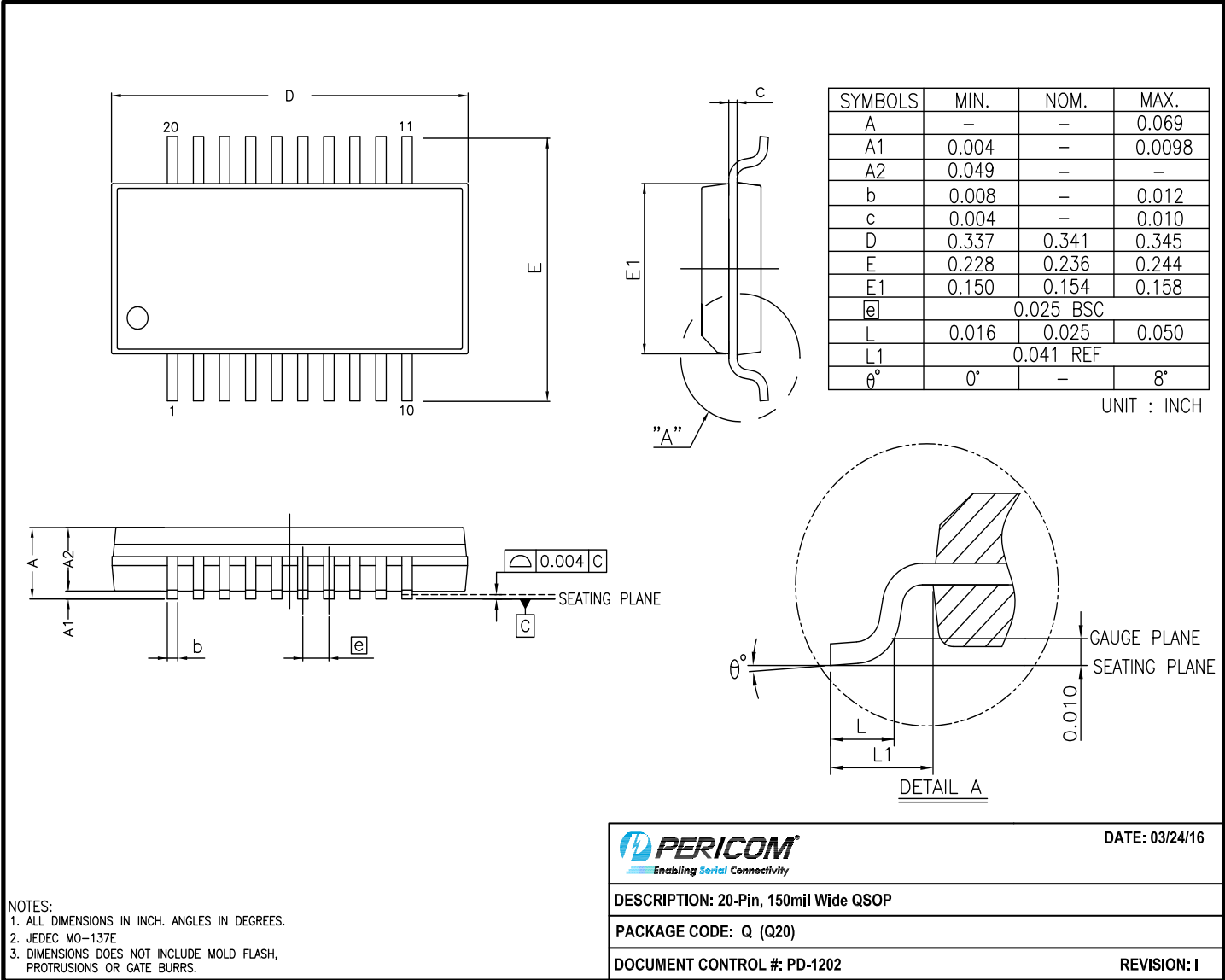
Pericom Semiconductor Corporation  
 3545 N. 1st Street, San Jose, CA 95134  
 1-800-435-2335 • www.pericom.com

DESCRIPTION: 20-Pin, 300-Mil Wide, SOIC

PACKAGE CODE: S

**PI3B3245**

**Packaging Mechanical: 20-QSOP (Q)**



16-0057

**PI3B3245**

**Packaging Mechanical: 20-UQFN (ZUA)**

**TOP VIEW**

**BOTTOM VIEW**

**SIDE VIEW**

**RECOMMENDED LAND PATTERN(unit:mm)**

PKG. DIMENSIONS(MM)			
SYMBOL	Min	NOM	Max
A	0.55	0.60	0.65
A1	0.00	0.02	0.05
A3	0.15 REF		
D	3.95	4.00	4.05
E	3.95	4.00	4.05
D1	2.40	2.50	2.60
E1	2.40	2.50	2.60
b	0.20	0.25	0.30
e	0.50 BSC		
L	0.35	0.40	0.45

**Note:**  
1. Comly with JEDEC MO-248K, except 'A3', 'D1' and 'E1'.

**DIODES** **PERICOM**  
SHARING SERIAL CONNECTIVITY

**DATE: 03/29/17**

**DESCRIPTION: 20-Pin, UQFN, 4x4**

**PACKAGE CODE: ZUA (ZUA20)**

**DOCUMENT CONTROL #: PD-2223** **REVISION: -**

17-0031

**PI3B3245**

**Packaging Mechanical: 20-TSSOP (L)**

SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.20
A1	0.05	—	0.15
A2	0.80	1.00	1.05
b	0.19	—	0.30
C	0.09	—	0.20
D	6.40	6.50	6.60
E1	4.30	4.40	4.50
E	6.20	6.40	6.60
e	0.65 BSC		
L1	1.00 REF		
L	0.45	0.60	0.75
S	0.20	—	—
$\theta$	0°	—	8°

NOTES:  
 1. ALL DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.  
 2. JEDEC MO-153F  
 3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

16-0074

		DATE: 03/31/16
DESCRIPTION: 20-Pin, 173mil Wide TSSOP		
PACKAGE CODE: L (L20)		
DOCUMENT CONTROL #:	PD-1311	REVISION: G

For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

**Ordering Information**

Ordering Code	Package Code	Package Type
PI3B3245SEX	S	20-pin, 300Mil Wide (SOIC)
PI3B3245QEX	Q	20-pin, 150mil Wide (QSOP)
PI3B3245ZUAEX	ZUA	20-pin, 4x4 (UQFN)
PI3B3245LEX	L	20-pin, 173mil Wide (TSSOP)

**Notes:**

- EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- See <http://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. Thermal characteristics can be found on the company web site at [www.diodes.com/design/support/packaging/](http://www.diodes.com/design/support/packaging/)
- E = Pb-free and Green
- X suffix = Tape/Reel



#### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and definitive format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2016, Diodes Incorporated

[www.diodes.com](http://www.diodes.com)

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А